



## Technical Data Sheet

### 0.6mm Height Flat Top LED

19-213/W1D-ANPQY/3T

#### Features

- Package in 8mm tape on 7" diameter reel.
- Compatible with automatic placement equipment.
- Compatible with infrared and vapor phase reflow solder process.
- Mono-color type.

#### Descriptions

- The 19-213 SMD Taping is much smaller than lead frame type components, thus enable smaller board size, higher packing density, reduced storage space and finally smaller equipment to be obtained.
- Besides, lightweight makes them ideal for miniature applications. etc.

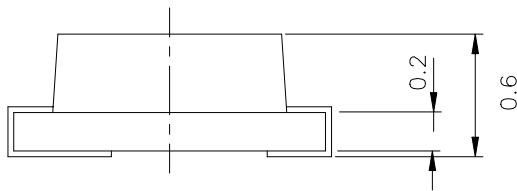
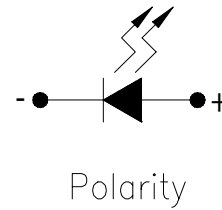
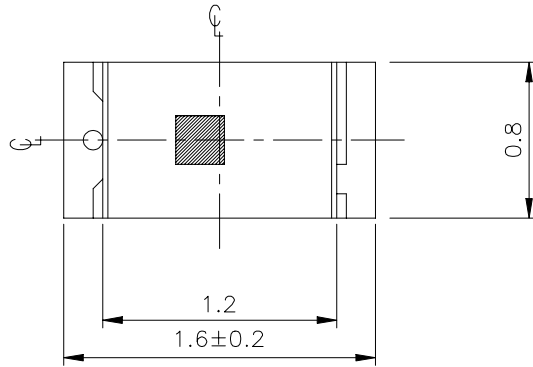
#### Applications

- Automotive: backlighting in dashboard and switch.
- Telecommunication: indicator and backlighting in telephone and fax.
- Flat backlight for LCD, switch and symbol.
- General use.

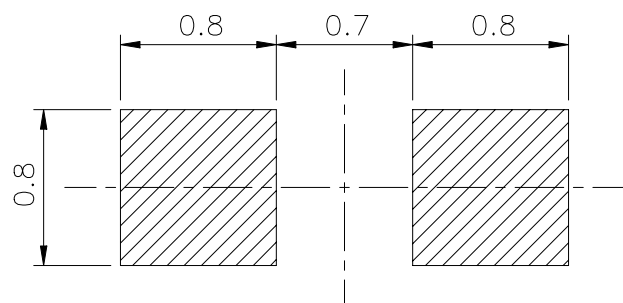
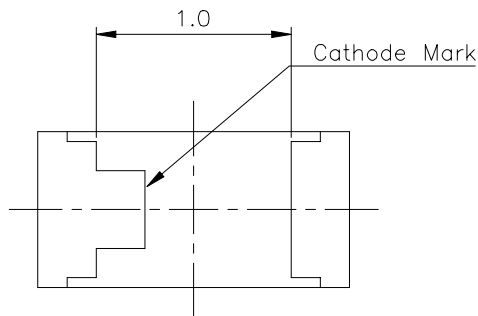
#### Device Selection Guide

Part No.	Chip		Lens Color
	Material	Emitted Color	
19-213/W1D-ANPQY/3T	InGaN	Pure White	Yellow Diffused

## Package Outline Dimensions



For reflow soldering (Propose)



**Note:** The tolerances unless mentioned is  $\pm 0.1\text{mm}$  , Angle $\pm 0.5^\circ$  ,Unit = mm

**19-213/W1D-ANPQY/3T**
**Absolute Maximum Ratings (Ta=25°C)**

Parameter	Symbol	Rating	Unit
Reverse Voltage	V <sub>R</sub>	5	V
Forward Current	I <sub>F</sub>	25	mA
Operating Temperature	T <sub>opr</sub>	-40 ~ +85	°C
Storage Temperature	T <sub>stg</sub>	-40 ~ +90	°C
Soldering Temperature	T <sub>sol</sub>	260 (for 5 seconds)	°C
Power Dissipation	P <sub>d</sub>	110	mW
Electrostatic Discharge	ESD	150	V
Peak Forward Current (Duty 1/10 @1KHz)	I <sub>F</sub>	100	mA

**Electro-Optical Characteristics (Ta=25°C)**

Parameter	Symbol	Min.	Typ.	Max.	Unit	Condition
Luminous Intensity	I <sub>v</sub>	28.5	-----	72.0	mcd	I <sub>F</sub> =5mA
Viewing Angle	2 θ 1/2	-----	130	-----	deg	I <sub>F</sub> =5mA
Forward Voltage	V <sub>F</sub>	2.7	-----	3.2	V	I <sub>F</sub> =5mA
Reverse Current	I <sub>R</sub>	-----	-----	50	μ A	V <sub>R</sub> =5V

**Bin Range Of Luminous Intensity & Forward Voltage**

Symbol	Bin Code	Min.	Max.	Unit	Condition
I <sub>v</sub>	N	28.5	45.0	mcd	I <sub>F</sub> =5mA
	P	45.0	72.0		
V <sub>F</sub>	19	2.7	2.8	V	I <sub>F</sub> =5mA
	20	2.8	2.9		
	21	2.9	3.0		
	22	3.0	3.1		
	23	3.1	3.2		

Notes:

**1.Tolerance of Luminous Intensity ± 15%**

**2.Tolerance of Forward Voltage ± 0.05V**

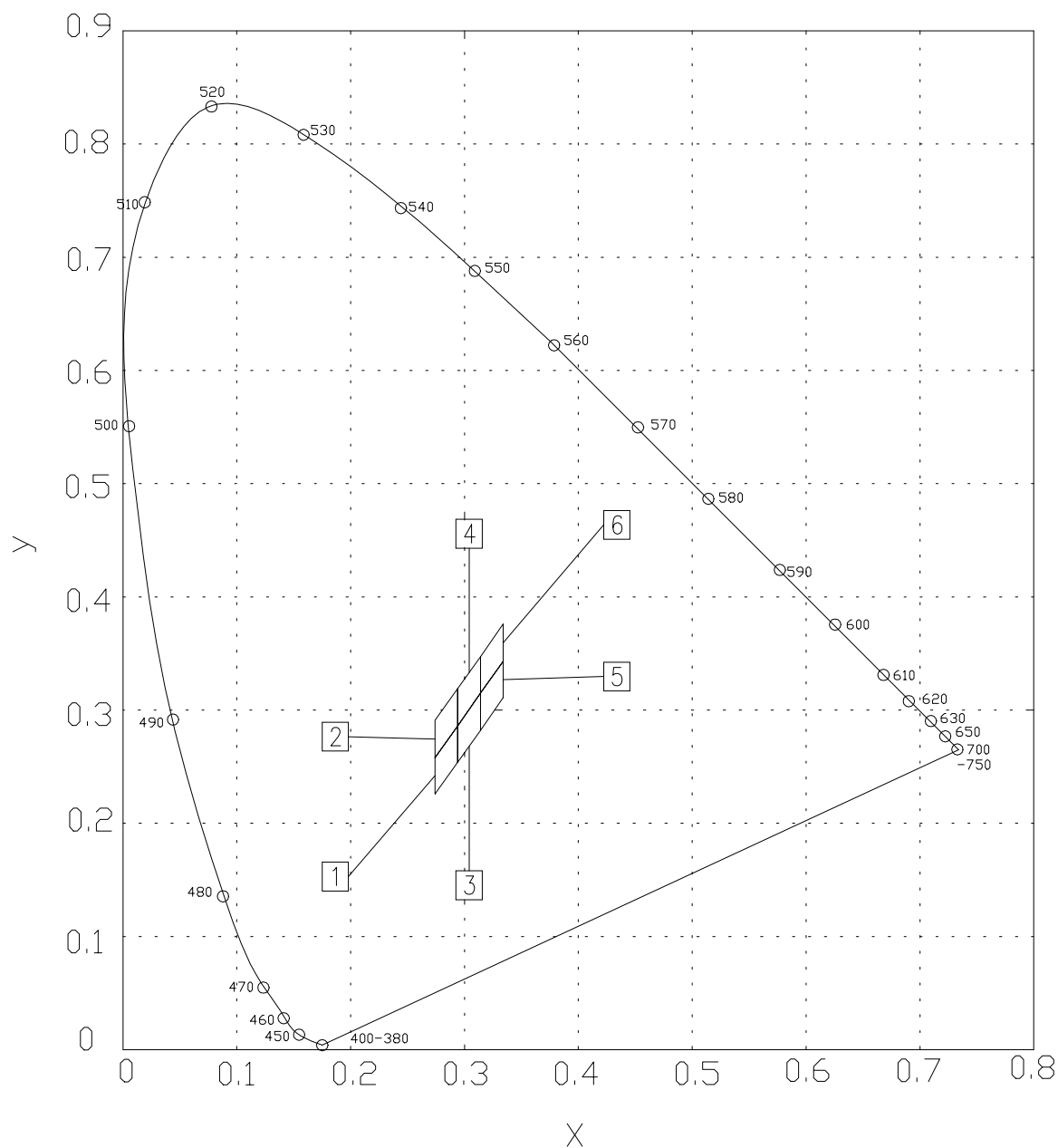
**Chromaticity Coordinates Specifications for Bin Grading**
**IF= 5mA**

Groups	Bin Code	CIE_x	CIE_y
A	1	0.274	0.226
		0.274	0.258
		0.294	0.286
		0.294	0.254
	2	0.274	0.258
		0.274	0.291
		0.294	0.319
		0.294	0.286
	3	0.294	0.254
		0.294	0.286
		0.314	0.315
		0.314	0.282
	4	0.294	0.286
		0.294	0.319
		0.314	0.347
		0.314	0.315
	5	0.314	0.282
		0.314	0.315
		0.334	0.343
		0.334	0.311
	6	0.314	0.315
		0.314	0.347
		0.334	0.376
		0.334	0.343

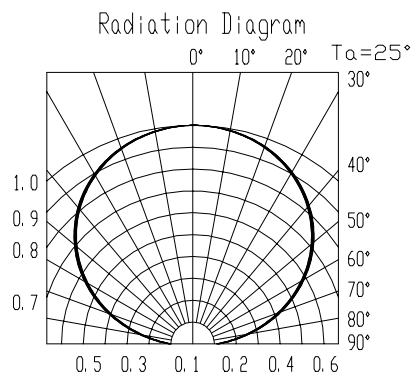
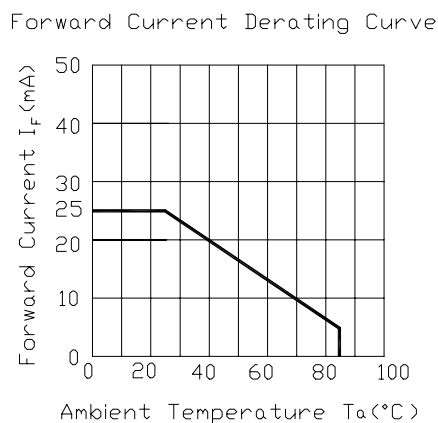
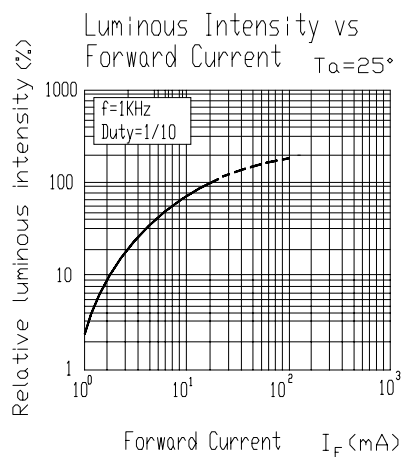
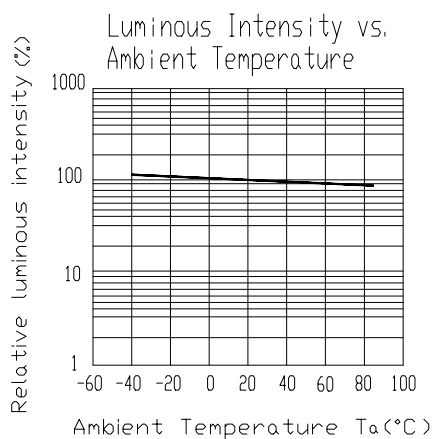
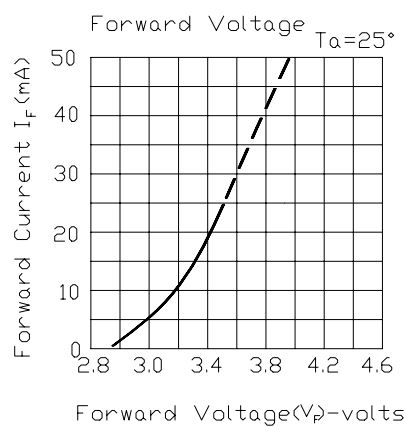
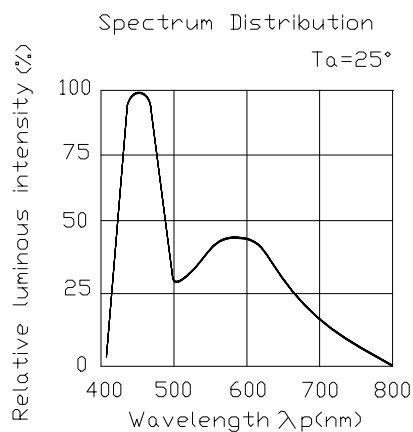
**Notes:**

- 1.The C.I.E. 1931 chromaticity diagram ( Tolerance  $\pm 0.01$ ).**
- 2.The products are sensitive to static electricity and care must be fully taken when handling products.**

## ■CIE Chromaticity Diagram

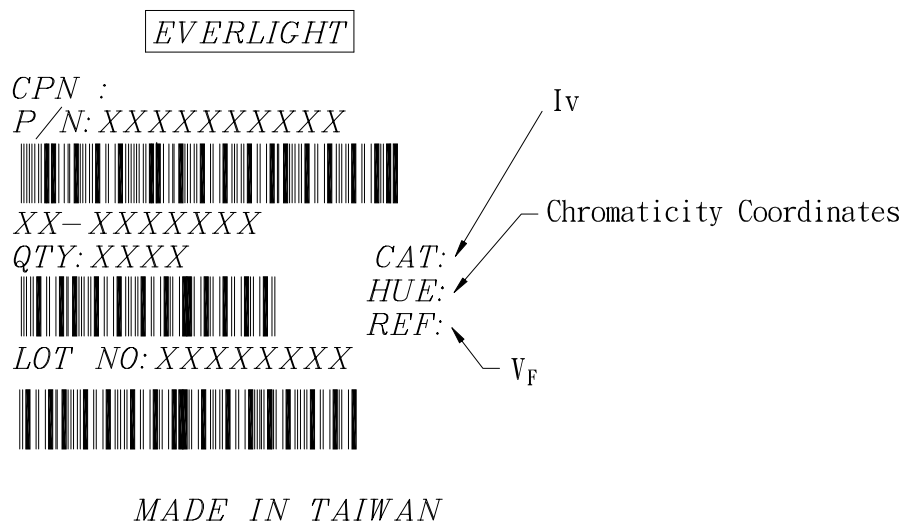


## Typical Electro-Optical Characteristics Curves

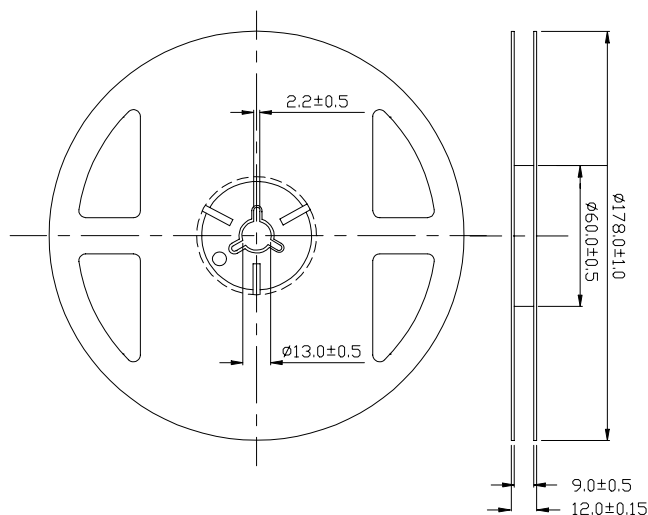


## Label explanation

CAT: Luminous Intensity (mcd) HUE: Chromaticity Coordinates REF: Forward Voltage (V)



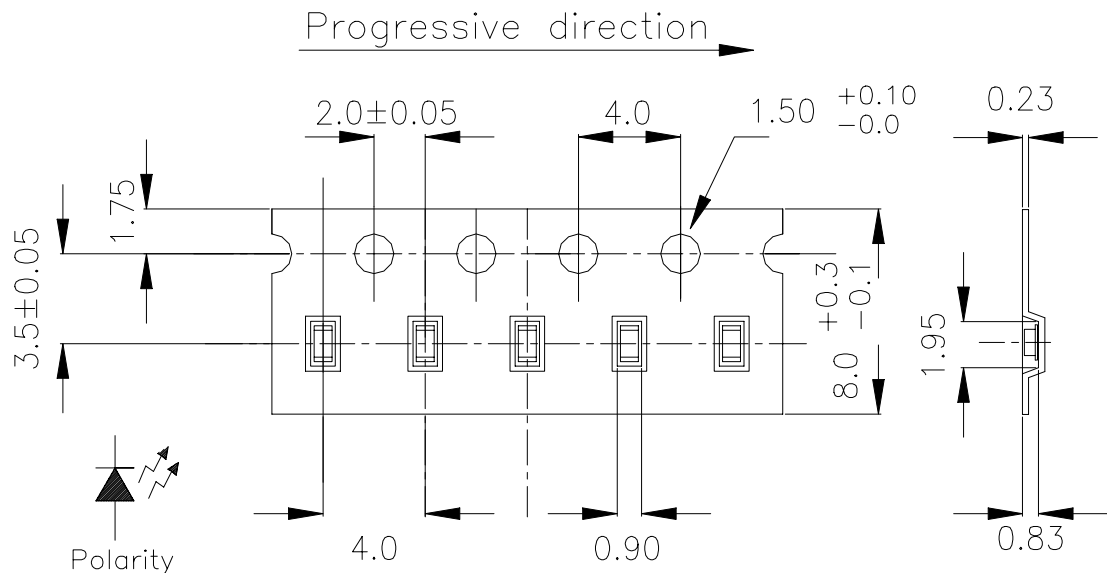
## Reel Dimensions



Taping Quantity: 3000pcs

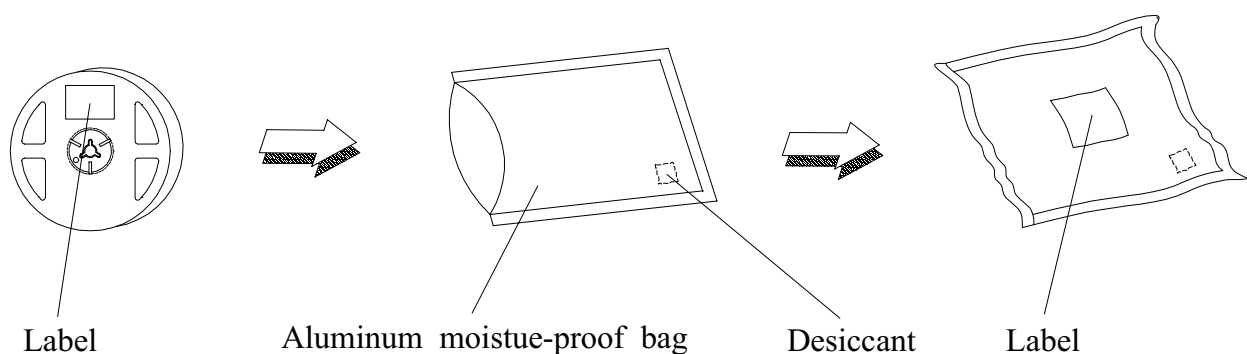
**Note:** The tolerances unless mentioned is  $\pm 0.1\text{mm}$ , Angle  $\pm 0.5^\circ$ , Unit = mm

## Carrier Tape Dimensions



**Note:** The tolerances unless mentioned is  $\pm 0.1\text{mm}$  , Angle $\pm 0.5^\circ$  ,Unit = mm

## Moisture Resistant Packaging



**Reliability Test Items And Conditions**

The reliability of products shall be satisfied with items listed below.

Confidence level : 90 %

LTPD : 10 %

No.	Items	Test Condition	Test Hours/Cycles	Sample Size	Ac/Rc
1	Reflow	Temp. : 240°C ± 5°C Min. 5 sec.	6 min.	22 Pcs.	0/1
2	Temperature Cycle	H : +100°C 15min. ∫ 5 min. L : -40°C 15min.	300 Cycles	22 Pcs.	0/1
3	Thermal Shock	H : +100°C 5min. ∫ 10 sec. L : -10°C 5min.	300 Cycles	22 Pcs.	0/1
4	High Temperature Storage	Temp. : 100°C	1000 Hrs.	22 Pcs.	0/1
5	Low Temperature Storage	Temp. : -55°C	1000 Hrs.	22 Pcs.	0/1
6	DC Operating Life	I <sub>F</sub> = 20 mA	1000 Hrs.	22 Pcs.	0/1
7	High Temperature / High Humidity	85°C/R.H85%	1000 Hrs.	22 Pcs.	0/1

## Precautions For Use

### 1. Over-current-proof

Customer must apply resistors for protection , otherwise slight voltage shift will cause big current change ( Burn out will happen ).

### 2. Storage time

2.1 The operation of Temperature and RH are :  $5^{\circ}\text{C}\sim 35^{\circ}\text{C}$  , RH60%.

2.2 Once the package is opened, the products should be used within a week.

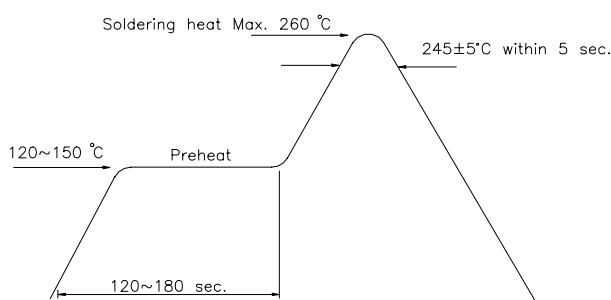
Otherwise, they should be kept in a damp proof box with descanting agent.

Considering the tape life , we suggest our customers to use our products within a year(from production date).

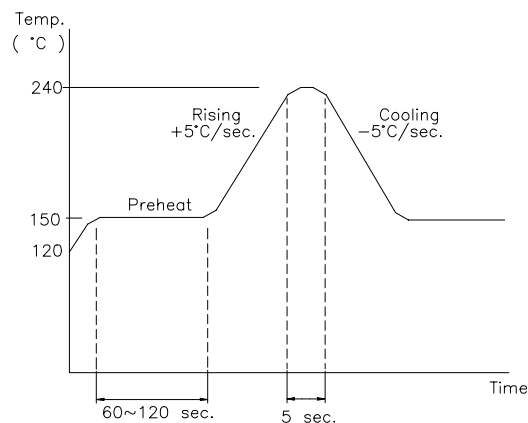
2.3 If opened more than one week in an atmosphere  $5^{\circ}\text{C}\sim 35^{\circ}\text{C}$  , RH 60%, they should be treated at  $60^{\circ}\text{C}\pm 5^{\circ}\text{C}$  for 15hrs.

2.4 When you discover that the desiccant in the package has a pink color (Normal = blue) , you should treat them in the same conditions as 2.3.

## Soldering heat



## Reflow Temp / Time

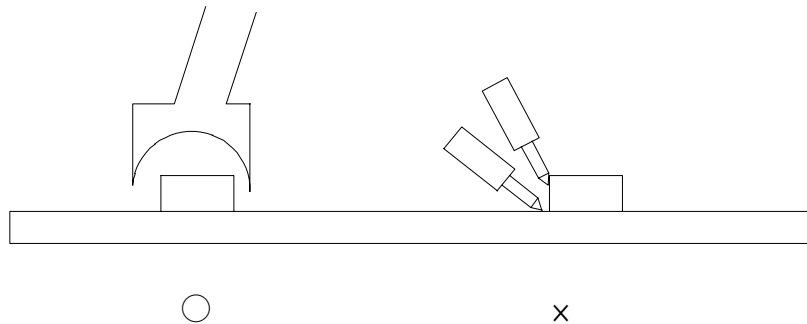


## Soldering Iron

Basic spec is  $\leq 5$  sec when  $260^{\circ}\text{C}$ . If temperature is higher, time should be shorter ( $+10^{\circ}\text{C} \rightarrow -1\text{sec}$ ). Power dissipation of Iron should be smaller than 15 W , and temperature should be controllable. Surface temperature of the device should be under  $230^{\circ}\text{C}$ .

### Rework

1. Customer must finish rework within 5 sec under 245°C.
2. The head of iron can not touch copper foil.
3. Twin-head type is preferred.



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